TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

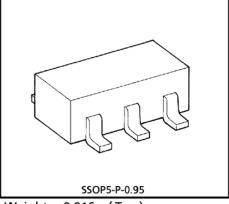
TC4S11F

2 INPUT NAND GATE

The TC4S11F is 2-input positive logic NAND gates. Gate output with inverter buffer improve the input-output characteristics and even if the load capacitance increases, it can be stopped the change of propagation time.

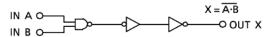
MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
DC Supply Voltage	V_{DD}	$V_{SS} - 0.5 \sim V_{SS} + 20$	V
Input Voltage	VIN	$V_{SS} = 0.5 \sim V_{DD} + 0.5$	V
Output Voltage	Vout	$V_{SS} - 0.5 \sim V_{DD} + 0.5$	V
DC Input Current	IN	± 10	mA
Power Dissipation	PD	200	mW
Operating Temperature Range	T _{opr}	- 40~85	°C
Storage Temperature Range	T _{stg}	- 65~150	°C
Lead Temperature (10s)	TL	260	°C

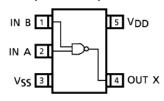


Weight: 0.016g (Typ.)

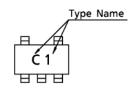
LOGIC DIAGRAM



PIN CONFIGURATION (TOP VIEW)



MARKING



RECOMMENDED OPERATING CONDITIONS ($V_{SS} = 0V$)

CHARACTERISTIC	SYMBOL		MIN.	TYP.	MAX.	UNIT
DC Supply Voltage	V_{DD}	_	3		18	V
Input Voltage	VIN		0	l	V_{DD}	V

STATIC ELECTRICAL CHARACTERISTICS ($V_{SS} = 0V$)

CHARACTERISTIC		SYM-	TEST CONDITION	V _{DD}	– 40°C		25°C			85°C		UNIT
CHARACTERISTIC	BOL	MIN.			MAX.	MIN.	TYP.	MAX.	MIN.	MAX.	ONIT	
High-Level	1		llour / 1,,A	5	4.95	_	4.95	5.00	_	4.95	_	
Output Voltage	VOH	I _{OUT} <1μΑ V _{IN} =V _{SS} , V _{DD}	10	9.95		9.95	10.00	—	9.95			
Output ve	ritage		VIN - 422, ADD	15	14.95		14.95	15.00		14.95		v
Low-Level			 l _{OUT} <1μΑ	5	–	0.05	—	0.00	ı	—	0.05	*
Output Vo		VOL	$V_{IN} = V_{DD}$	10	—	0.05	—	0.00	l	—	0.05	
Output ve	Jitage			15	_	0.05	_	0.00	0.05	_	0.05	
			V _{OH} = 4.6V	5	- 0.61		- 0.51	- 1.0	l	- 0.42	–	
Output Hi	ah		V _{OH} = 2.5V	5	– 2.5		- 2.1	- 4.0	1	- 1.7	—	
Current	gii	Іон	V _{OH} = 9.5V	10	- 1.5		- 1.3	- 2.2	ı	- 1.1	I	
Current			V _{OH} = 13.5V	15	- 4.0	_	- 3.4	- 9.0	—	- 2.8	_	
			$V_{IN} = V_{SS}, V_{DD}$									mΑ
			$V_{OL} = 0.4V$	5	0.61	_	0.51	1.2	ı	0.42	–	IIIA
Output Lo	w	lOL	V _{OL} = 0.5V	10	1.5	_	1.3	3.2	l	1.1	l .	
Current		'OL	V _{OL} = 1.5V	15	4.0	—	3.4	12.0	 	2.8	_	
			$V_{IN} = V_{DD}$									
			V _{OUT} = 0.5V, 4.5V	5	3.5		3.5	2.75	ı	3.5	_	
Input High	. Valtaga	\ _{\\\}	V _{OUT} = 1.0V, 9.0V	10	7.0	_	7.0	5.5	 	7.0	_	
iliput nigi	voitage	VIH	V _{OUT} = 1.5V, 13.5V	15	11.0	_	11.0	8.25	 	11.0	 	
			l _{OUT} <1μΑ									v
			V _{OUT} = 4.5V	5		1.5	_	2.25	1.5	—	1.5	
Input Low Voltage	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	V _{OUT} = 9.0V	10	—	3.0		4.5	3.0	—	3.0		
	VIL	V _{OUT} = 13.5V	15	_	4.0	—	6.75	4.0	—	4.0		
			l _{OUT} <1μΑ									
Input	H Level	ΊΗ	V _{IH} = 18V	18	_	0.1	_	10-5		_	1.0	
Current	L Level	Ι _Ι L	V _{IL} = 0V	18		- 0.1	_	- 10 ^{- 5}	-0.1	_	- 1.0	μ A
Quiescent Device Current		V _{IN} = V _{SS} , V _{DD}	5	_	0.25	_	0.001	0.25	_	7.5		
		lDD	* * N = v\$\$, vDD	10	—	0.5		0.001	0.5	—	15	μ A
			"	15	_	1.0	—	0.002	1.0	—	30	

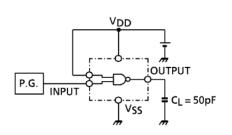
^{*} All valid input combinations.

DYNAMIC ELECTRICAL	CHARACTERISTICS	$(Ta = 25^{\circ}C)$	Vcc = 0V	$C_1 = 50 pF$
DINVINC FFFCIVICAL		(I a – 23 C,	V < \ - U V ,	

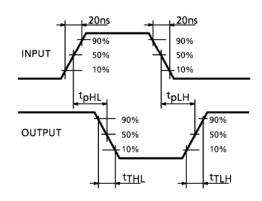
CHARACTERISTIC	SYMBOL	TEST CONDITION	V _{DD} (V)	MIN.	TYP.	MAX.	UNIT
Output Transition Time			5		70	200	
_	tTLH	_	10	_	35	100	ns
(Low to High)			15	_	30	80	
Output Transition Time (High to Low)			5		70	200	
	[†] THL	_	10	_	35	100	
			15	_	30	80	
	t _{pLH}	_	5		65	200	
Propagation Delay Time			10	_	30	100	
			15	_	25	80	
Propagation Delay Time	t _{pHL}	_	5		65	200	ns
			10	_	30	100	
			15	_	25	80	
Input Capacitance	CIN	_		5	7.5	pF	

CIRCUIT AND WAVEFORM FOR MEASUREMENT OF DYNAMIC CHARACTERISTICS

TEST CIRCUIT

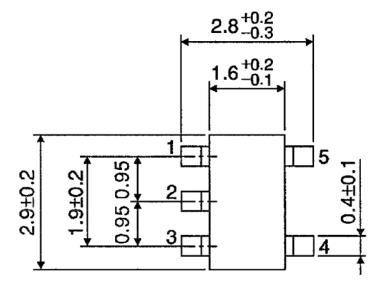


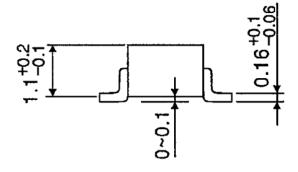
WAVEFORM



PACKAGE DIMENSIONS SSOP5-P-0.95

Unit: mm





Weight: 0.016g (Typ.)

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